



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max Tc = +25°C
	5.0mΩ @ V _{GS} = 10V	87A
30V	7.4mΩ @ V _{GS} = 4.5V	71A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Backlighting
- · Power-management functions
- DC-DC converters

Features and Benefits

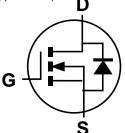
- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

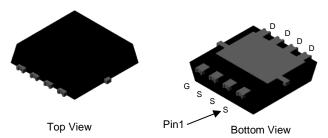
- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)

Weight: 0.072 grams (Approximate)



Equivalent Circuit

PowerDI3333-8 (SWP) (Type UX)



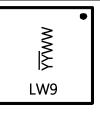
Ordering Information (Note 4)

Part Number	Package	Packing		
Part Number	Fackage	Qty.	Carrier	
DMN39M1LFVW-7	PowerDI3333-8 (SWP) (Type UX)	2,000	Tape & Reel	
DMN39M1LFVW-13	PowerDI3333-8 (SWP) (Type UX)	3.000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



LW9 = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 23 = 2023)

WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	30	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 7) $V_{GS} = 10V$ $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$		ΙD	87 69	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	lом	329	Α	
Maximum Continuous Body Diode Forward Current (Note 7)	Is	2.1	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	lsм	329	Α	
Avalanche Current, L = 0.1mH (Note 8)	las	38	Α	
Avalanche Energy, L = 0.1mH (Note 8)	E _{AS}	72	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	96	°C/W
Total Power Dissipation (Note 6)		P_{D}	2.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	46	°C/W
Thermal Resistance, Junction to Case (Note 7)		R _θ JC	2.2	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

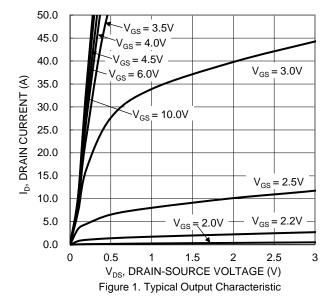
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V$, $I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 24V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	Vgs(TH)	1	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	Pro/OND		3.3	5.0	mΩ	$V_{GS} = 10V, I_{D} = 30A$
Static Drain-Source On-Resistance	RDS(ON)		5.7	7.4	11177	V _{GS} = 4.5V, I _D = 15A
Diode Forward Voltage	VsD		0.7	1.2	V	$V_{GS} = 0V$, $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 10)					
Input Capacitance	Ciss		2387	_	pF	15)/)/0)/
Output Capacitance	Coss		292		pF	V _{DS} = 15V, V _{GS} = 0V, - f = 1MHz
Reverse Transfer Capacitance	Crss		208	_	pF	I - IIVII IZ
Gate Resistance	Rg	_	2.4	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	19	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	40	_	nC	
Gate-Source Charge	Qgs	_	7.8	_	nC	V_{DS} = 15V, I_{D} = 15A
Gate-Drain Charge	Qgd	_	5.6	_	nC	1
Turn-On Delay Time	t _{D(ON)}	_	4.3	_	ns	
Turn-On Rise Time	tR	_	3.8	_	ns	V _{DD} = 15V, V _{GS} = 10V,
Turn-Off Delay Time	tD(OFF)	_	39	_	ns	R _G = 3.3Ω, I _D = 15A
Turn-Off Fall Time	tF		11	_	ns	1
Body Diode Reverse Recovery Time	trr	_	20.49	_	ns	154 114 1004/
Body Diode Reverse Recovery Charge	Q _{RR}	_	8.93	_	nC	I _F = 15A, di/dt = 100A/μs

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_{J} = +25^{\circ}C$.
- Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.







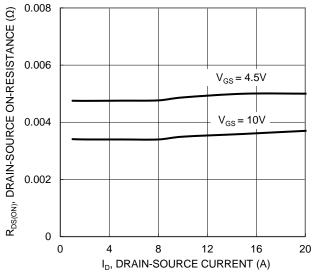


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

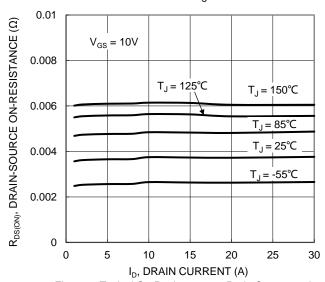


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

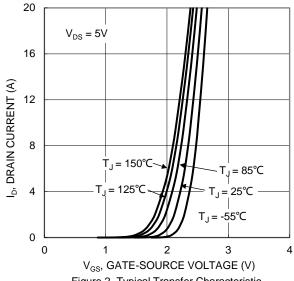
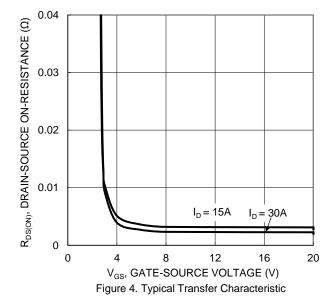


Figure 2. Typical Transfer Characteristic



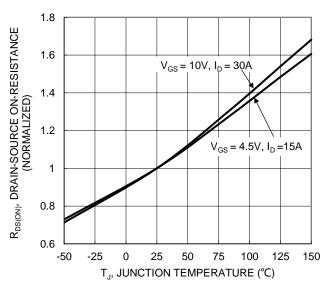


Figure 6. On-Resistance Variation with Temperature





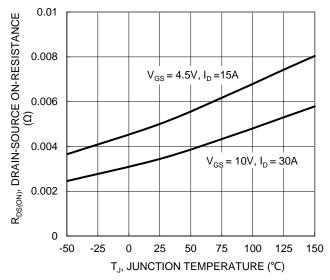


Figure 7. On-Resistance Variation with Temperature

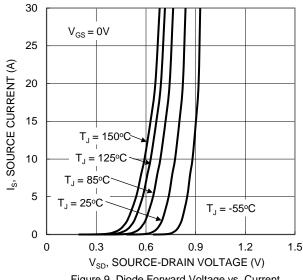
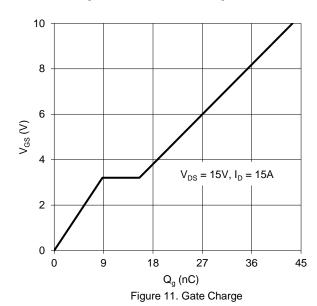


Figure 9. Diode Forward Voltage vs. Current



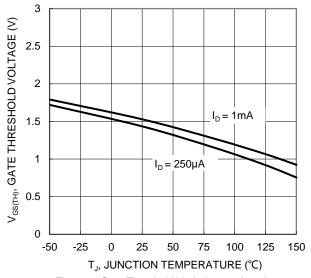
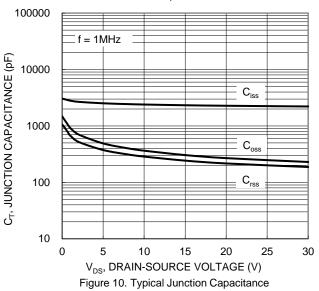


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ 100 ID, DRAIN CURRENT (A) $= 10 \mu s$ 10 $P_{W} = 100 \mu s$ T_{J(Max)} = 150°C $T_{C} = 25^{\circ}C$ Single Pulse = 100 ms**DUT** on Infinite DC Heatsink $V_{GS} = 10V$ 0.1 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



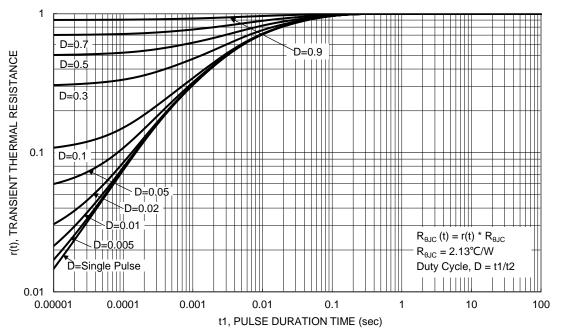


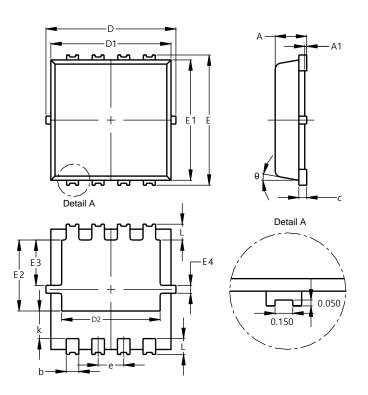
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)

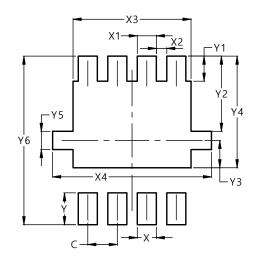


PowerDI3333-8 (SWP)					
(Type UX)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
E	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E3	0.95	1.35	1.15		
E4	0.10	0.30	0.20		
е	_	_	0.65		
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)
C	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.600
X4	3.500
Υ	0.700
Y1	0.550
Y2	1.650
Y3	0.600
Y4	2.450
Y5	0.400
Y6	3.700



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